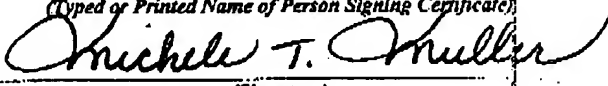


<b>CERTIFICATE OF TRANSMISSION BY FACSIMILE (37 CFR 1.8)</b>			Docket No. <b>FR-AM1894 NP</b>
Applicant(s): <b>HIDALGO, M. et al</b>			
Application No. <b>10/532,385</b>	Filing Date <b>04/21/2005</b>	Examiner <b>Not yet assigned</b>	Group Art Unit <b>N/A</b>
Invention: <b>DUCTILE AND TRANSPARENT THERMOPLASTIC COMPOSITIONS COMPRISING AN AMORPHOUS MATRIX AND A BLOCK COPOLYMER</b>			
<b>RECEIVED</b> <b>CENTRAL FAX CENTER</b> <b>JUL 20 2005</b>			
I hereby certify that this <u>Information Disclosure Statement along with attached form PTO 1449</u> (Identify type of correspondence) is being facsimile transmitted to the United States Patent and Trademark Office (Fax. No. <u>571-273-8300</u> ) on <u>July 20, 2005</u> (Date)			
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## INFORMATION DISCLOSURE CITATION

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FR-AM1894 NP

19/532.385

APPLICANT(S)

HIDALGO, M. et al

FILING DATE

04/21/2005

GROUP ART UNIT

Not yet assigned

## U.S. PATENT DOCUMENTS

*EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
	1.	US 5,476,904	19DEC95	HEIM, P. et al			
	2.	US 5,306,778	26APR94	ISHIDA, A. et al			
	3.	US 4,423,188	27DEC83	WITSCHARD, Gilbert			
	4.	US 5,434,219	18JUL95	OOMURA, K. et al			
	5.	US 6,254,712	03JUL01	ENLOW, H. et al			

## U.S. PATENT APPLICATION PUBLICATIONS

*EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE

## FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
							YES	NO
	1.	EP 0307818	09SEP88	EP				✓

## OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)


EXAMINER

DATE CONSIDERED

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